

STPS30M60DJF

High efficiency power Schottky diode

Datasheet - production data

Features

- Very low conduction losses
- Low forward voltage drop
- Low thermal resistance
- High specified avalanche capability
- High integration
- ECOPACK[®]2 compliant component

Description

The STPS30M60DJF is a power Schottky rectifier, suited for high frequency switch mode power supply and DC to DC converters.

Packaged in PowerFLAT™, this device is intended to be used in notebook, game station and desktop adapters, providing in these applications a good efficiency at both low and high load. Its low profile was especially designed to be used in applications with space-saving constraints.

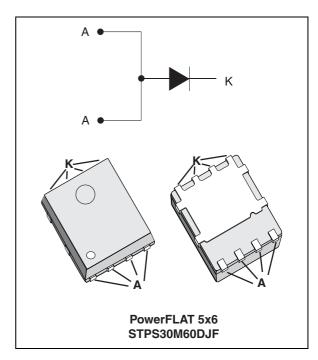


Table 1. Device summary

Symbol	Value
I _{F(AV)}	30 A
V _{RRM}	60 V
V _F (typ)	0.46 V
T _j (max)	150 °C

TM: PowerFLAT is a trademark of STMicroelectronics

Characteristics STPS30M60DJF

Characteristics 1

Table 2. Absolute ratings (limiting values, anode terminals 1 and 3 short circuited)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage		60	V
I _{F(RMS)}	Forward rms current		45	Α
I _{F(AV)}	Average forward current $\delta = 0.5$	30	Α	
I _{FSM}	Surge non repetitive forward current	250	Α	
P _{ARM} ⁽¹⁾	Repetitive peak avalanche power	3500	W	
V _{ARM}	Maximum repetitive peak avalanche $t_p < 1~\mu s, T_j < 150~^{\circ} C$ voltage $I_{AR} < 13~A$		80	V
T _{stg}	Storage temperature range	-65 to +175	°C	
T _j	Maximum operating junction temperature	150	°C	

More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the STMicroelectronics' application notes AN1768 and AN2025.

Thermal resistance Table 3.

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	2.0	°C/W

Table 4. Static electrical characteristics (anode terminals short circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
{I} (1)	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	$V_R = V_{RRM}$	-	-	90	μΑ
'R'		T _j = 125 °C		-	20	50	mA
	V _F ⁽²⁾ Forward voltage drop	T _j = 25 °C	I _F = 15 A	-	-	0.59	V
V _E (2)		T _j = 125 °C		-	0.46	0.52	
V _E ····· I diward voltage drop	T _j = 25 °C	I _F = 30 A	-	-	0.72	•	
	T _j = 125 °C		-	0.57	0.67		

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses use the following equation: P = 0.55 x $I_{F(AV)}$ + 0.004 x I_{F}^{2} _(RMS)

$$P = 0.55 \times I_{E(AV)} + 0.004 \times I_{E}^{2}(BMS)$$

 $[\]frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

^{2.} Pulse test: $t_p = 380 \mu s$, $\delta < 2\%$

STPS30M60DJF Characteristics

Figure 1. Average forward power dissipation Figure 2. Average forward current versus versus average forward current ambient temperature (δ = 0.5)

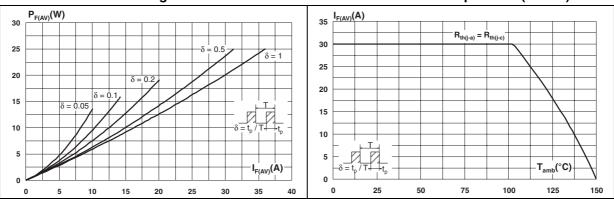


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature

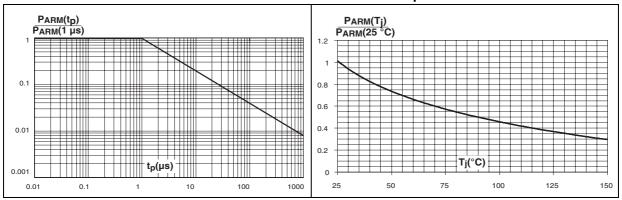
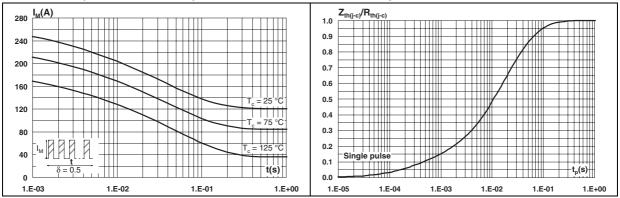


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)

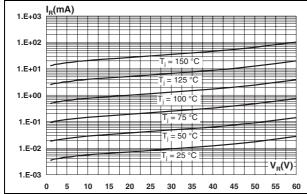
Figure 6. Relative variation of thermal impedance junction to case versus pulse duration



Characteristics STPS30M60DJF

Figure 7. Reverse leakage current versus reverse voltage applied (typical values)

Figure 8. Junction capacitance versus reverse voltage applied (typical values)



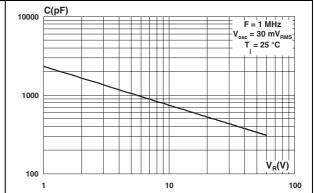
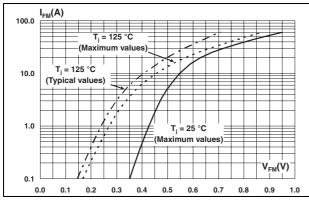


Figure 9. Forward voltage drop versus forward current

Figure 10. Thermal resistance junction to ambient versus copper surface under tab



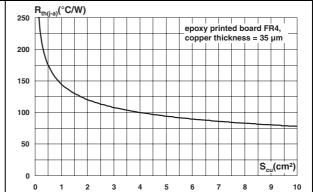
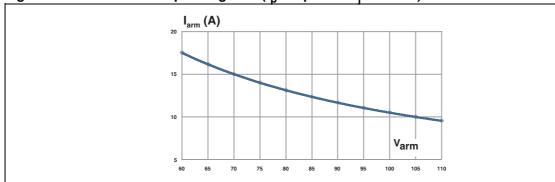


Figure 11. Reverse safe operating area ($t_p < 1 \mu s$ and $T_i < 150 °C$)

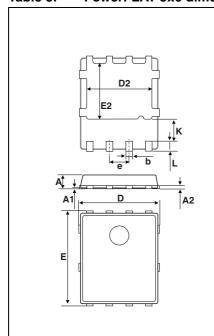


2 Package information

- Epoxy meets UL94,V0
- Lead-free package

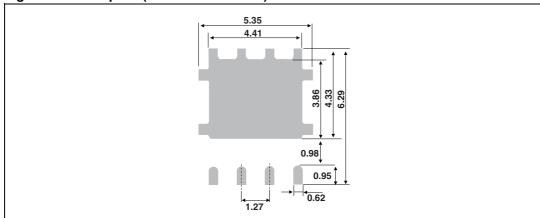
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 5. PowerFLAT 5x6 dimensions



	Dimensions					
Ref.	Millimeters		rs	Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	0.80		1.00	0.031		0.039
A1	0.02		0.05	0.001		0.002
A2		0.25			0.010	
b	0.30		0.50	0.012		0.020
D		5.20			0.205	
D2	4.11		4.31	0.162		0.170
е		1.27			0.050	
Е		6.15			0.242	
E2	3.50		3.70	0.138		0.146
L	0.50		0.80	0.020		0.031
K	1.275		1.575	0.050		0.062

Figure 12. Footprint (dimensions in mm)



Package information STPS30M60DJF

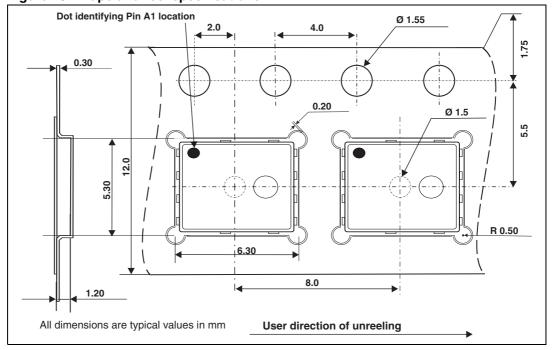


Figure 13. Tape and reel specifications

3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS30M60DJF-TR	PS30 M60	PowerFLAT 5x6	95 mg	3000	Tape and reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
18-Apr-2012	1	First issue.

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY TWO AUTHORIZED ST REPRESENTATIVES, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2012 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

477

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

STMicroelectronics: STPS30M60DJF-TR